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- Members of the Texas Instruments Widebus™ Family
- Inputs Are TTL-Voltage Compatible
- Flow-Through Architecture Optimizes
 PCB Layout
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- EPIC™ (Enhanced-Performance Implanted CMOS) 1-μm Process
- 500-mA Typical Latch-Up Immunity at 125°C
- Package Options Include Shrink Small-Outline 300-mil (DL) Packages Using 25-mil Center-to-Center Pin Spacings and 380-mil Fine-Pitch Ceramic Flat (WD) Packages Using 25-mil Center-to-Center Pin Spacings

description

The 'ACT16470 are 16-bit registered transceivers that contain two sets of D-type flip-flops for temporary storage of data flowing in either direction. They can be used as two 8-bit transceivers or one 16-bit transceiver. Separate clock (CLKAB or CLKBA) and output-enable (OEAB or OEBA) inputs are provided for each register to permit independent control in either direction of data flow.

The A-to-B enable (CEAB) input must be low to enter data from A or to output data to B. If both CEAB and CLKAB are low, then B port will have the level of A port prior to the most recent low-to-high transition of CLKAB. Data flow from B to A is similar, but requires the use of CEBA, CLKBA, and OEBA inputs.

54ACT16470 . . . WD PACKAGE 74ACT16470 . . . DL PACKAGE (TOP VIEW)



To avoid false clocking of the flip-flops, $\overline{\text{CE}}$ should not be switched from high to low while CLK is high.

The 74ACT16470 is packaged in TI's shrink small-outline package, which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The 54ACT16470 is characterized for operation over the full military temperature range of –55°C to 125°C. The 74ACT16470 is characterized for operation from –40°C to 85°C.



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FUNCTION TABLE†

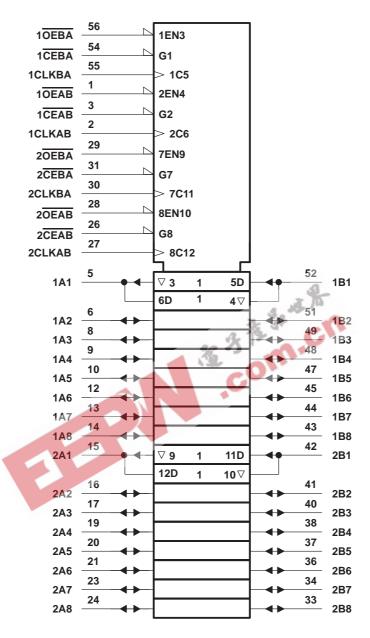
	INPUTS					
CEAB	CLKAB	OEAB	Α	В		
Н	Χ	Х	Χ	Z		
Х	X	Н	Χ	Z		
L	L	L	Χ	в ₀ ‡		
L	\uparrow	L	L	L		
L	1	L	Н	Н		

[†] A-to-B data flow is shown: B-to-A flow is similar but uses CEBA, CLKBA, and OEBA. ‡ Output level before the indicated steady-state input



conditions were established

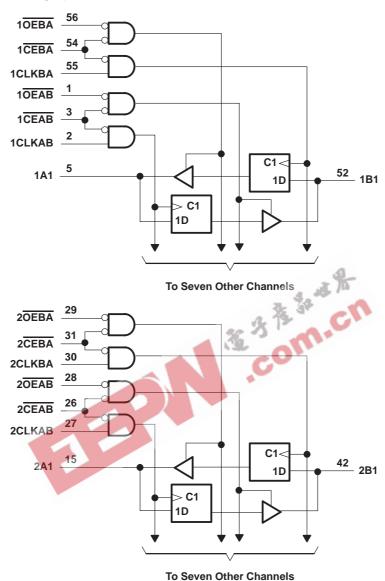
logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

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logic diagram (positive logic)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage range, V _{CC}	–0.5 to 7 V
Input voltage range, V _I (see Note 1)	-0.5 to $V_{CC} + 0.5 V$
Input voltage range, V _O (see Note 1)	-0.5 to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)	±20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	±50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±50 mA
Continuous current through V _{CC} or GND	±400 mA
Maximum power package dissipation at T _A = 55°C (in still air)(see Note 2): DL package	1.4 W
Storage temperature range, T _{stq}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 3)

		54ACT16470	74ACT16470	UNIT
		MIN NOM MAX	MIN NOM MAX	ONIT
Vcc	Supply voltage	4.5 5 5. 5	4.5 5 5.5	V
VIH	High-level input voltage	2	2	V
V _{IL}	Low-level input voltage	0.8	0.8	V
VI	Input voltage	0 VCC	0 V _{CC}	V
VO	Output voltage	0 VCC	0 V _{CC}	V
ІОН	High-level output current	-24	-24	mA
loL	Low-level output current	24	24	mA
Δt/Δν	Input transition rise or fall rate	0 10	0 10	ns/V
TA	Operating free-air temperature	- 55 125	-40 85	°C

NOTE 3: Unused pins (input or I/O) must be held high or low to prevent them from floating.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

^{2.} The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V	T,	_A = 25°C	54ACT16470	74ACT16470		
PAI	RAMETER	TEST CONDITIONS	VCC	MIN	TYP MAX	MIN MA	MIN MAX	UNIT	
		10.1 - 50.11A	4.5 V	4.4		4.4	4.4		
		I _{OH} = -50 μA	5.5 V	5.4		5.4	5.4		
Vон		I _{OH} = -24 mA	4.5 V	3.94		3.8	3.8	V	
		IOH = -24 IIIA	5.5 V	4.94		4.8	4.8]	
		I _{OH} = -75 mA [†]	5.5 V			3.85	3.85		
		I _{OL} = 50 μA	4.5 V		0.1	0.	1 0.1	V	
		ΙΟΣ = 30 μΑ	5.5 V		0.1	& 0.	1 0.1		
VOL		I _{OL} = 24 mA	4.5 V		0.36	0.4	0.44		
		IOL = 24 IIIA	5.5 V		0.36	0.4	0.44		
	_	I _{OL} = 75 mA [†]	5.5 V			1.6	1.65		
lį	Control inputs	V _I = V _{CC} or GND	5.5 V		±0.1	±	1 ±1	μΑ	
loz‡	A or B ports	$V_O = V_{CC}$ or GND	5.5 V		±0.5	±	5 ±5	μΑ	
Icc		$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V		8	8	08	μΑ	
ΔICC§		One input at 3.4 V, Other inputs at V _{CC} or GND	5.5 V		0.9	cn	1	mA	
Ci	Control inputs	V _I = V _{CC} or GND	5 V	362	3			pF	
Cio	A or B ports	$V_O = V_{CC}$ or GND	5 V	Car	11.5			pF	

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

timing requirements over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

		T _A = 25°C		54ACT16470		74ACT16470		UNIT	
		MIN	MAX	MIN	MAX	MIN	MAX	UNIT	
fclock	Clock frequency		0	55	0	55	0	55	MHz
	Pulse duration CLK high CLK low		4		4	10,71	4		ns
t _w			8.5		8.5		8.5		
t _{su}	t _{SU} Setup time, data before CLK↑		6		6		6		ns
th	Hold time, data after CLK↑		1		1		1		ns

[‡] For I/O ports, the parameter IOZ includes the input leakage current.

[§] This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or VCC.

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switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

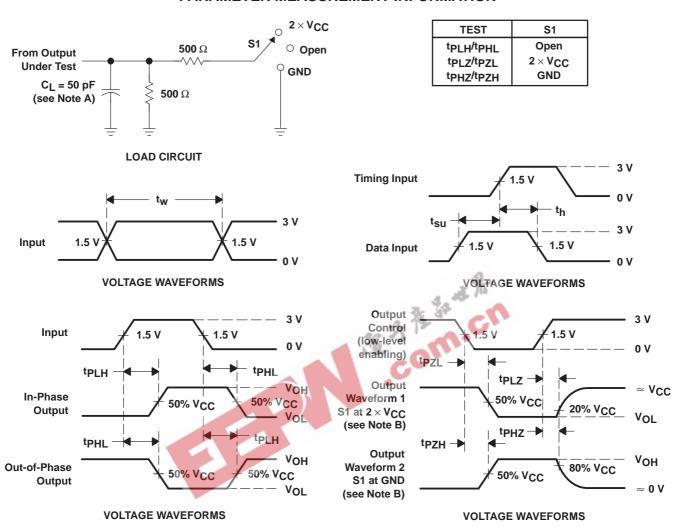
PARAMETER	FROM	то	T,	ղ = 25°C	;	54ACT	16470	74ACT	16470	UNIT
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
f _{max}			55			55		55		MHz
^t PLH	CLK	A or B	3.9	8.3	10.3	3.9	11.8	3.9	11.8	ns
t _{PHL}	CLK	AUIB	3.8	8.4	10.3	3.8	11.7	3.8	11.7	110
^t PZH	ŌĒ	OE A or B	3.2	8.3	10.5	3.2	11.9	3.2	11.9	no
^t PZL			3.6	9.5	11.8	3.6	13.4	3.6	13.4	ns
^t PHZ	ŌĒ	A or B	4.6	7.4	9.3	4.6	9.9	4.6	9.9	ns
^t PLZ	OE	AOIB	4.6	7	8.8	4.6	9.5	4.6	9.5	115
^t PZH		A or B	3.5	8.8	10.9	3.5	12.5	3.5	12.5	ns
^t PZL	CE		4.2	10.1	12.4	4.2	14.3	4.2	14.3	110
^t PHZ	CE A or B	A or P	5.2	8.3	10.3	5.2	11.2	5.2	11.2	no
^t PLZ		AUID	5.2	7.9	10	5.2	10.9	5.2	10.9	ns

operating characteristics, V_{CC} = 5 V, T_A = 25°C

	PARAMETER	3c 34	TEST CO	NDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance per transceiver	Outputs enabled	C _L = 50 pF,	f = 1 MHz	59	pF
Ора	1 ower dissipation capacitance per transceiver	Outputs disabled	о_ = 50 рг,	1 = 1 1011 12	39	Pi
		.co.				

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PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_I includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \Omega$, $t_f = 3 \text{ ns}$, $t_f = 3 \text{ ns}$.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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